C100E 38

5 EC ÷2, ÷4/6 Co n rP C

Description

The MC100EL38 is a low skew ÷2, ÷4/6 clock generation chip designed explicitly for low skew clock generation applications. The internal dividers are synchronous to each other, therefore, the common output edges are all precisely aligned. The device can be driven by either a differential or single-ended ECL or, if positive power supplies are used, PECL input signal.

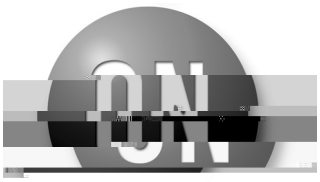
The V_{BB} pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to V_{BB} as a switching reference voltage. V_{BB} may also rebias AC coupled inputs. When used, decouple V_{BB} and V_{CC} via a 0.01 μF capacitor and limit current sourcing or sinking to 0.5 mA. When not used, V_{BB} should be left open.

The common enable ($\overline{EN}$) is synchronous so that the internal dividers will only be enabled/disabled when the internal clock is already in the LOW state. This avoids any chance of generating a runt clock pulse on the internal clock when the device is enabled/disabled as can happen with an asynchronous control. An internal runt pulse could lead to losing synchronization between the internal divider stages. The internal enable flip-flop is clocked on the falling edge of the input clock, therefore, all associated specification limits are referenced to the negative edge of the clock input.

The Phase_Out output will go HIGH for one clock cycle whenever the ÷2 and the ÷4/6 outputs are both transitioning from a LOW to a HIGH. This output allows for clock synchronization within the system.

Upon startup, the internal flip-flops will attain a random state; therefore, for systems which utilize multiple EL38s, the master reset (MR) input must be asserted to ensure synchronization. For systems which only use one EL38, the MR pin need not be exercised as the internal divider design ensures synchronization between the ÷2 and the ÷4/6 outputs of a single device.

- 50 ps Output-to-Output Skew
- Synchronous Enable/Disable
- Master Reset for Synchronization
- ESD Protection:
  - 2 kV Human Body Model
  - 100 V Machine Model
- The 100 Series Contains Temperature Compensation
- PECL Mode Operating Range:
  - V_{CC} = 4.2 V to 5.7 V with V_{EE} = 0 V
- NECL Mode Operating Range:
  - V_{CC} = 0 V with V_{EE} = 4.2 V to 5.7 V
- Internal 75 kΩ Input Pulldown Resistors on CLK, $\overline{EN}$, MR, and DIVSEL
- Q Output will Default LOW with Inputs Open or at V_{EE}
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level: 3 (Pb-Free)
  - For Additional Information, see Application Note AND8003/D
- Flammability Rating:
  - UL 94 V 0 @ 0.125 in, Oxygen Index: 28 to 34
- Transistor Count = 388 devices
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant



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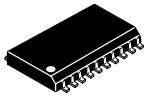
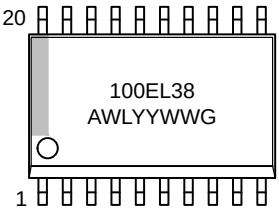


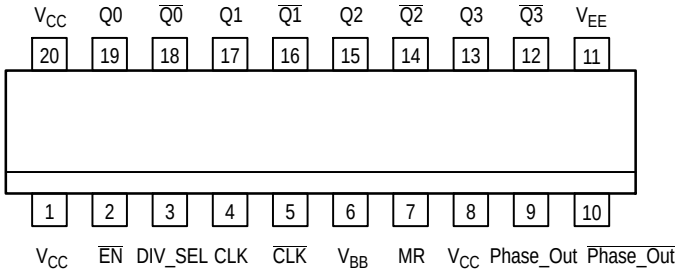
SOIC−20 WB
DW SUFFIX
CASE 751D−05

MARKING DIAGRAM*



A	= Assembly Location
WL	= Wafer Lot
YY	= Year
WW	= Work Week
G	= Pb-Free Package

*For additional marking information, refer to Application Note AND8002/D.



* All V_{CC} pins are tied together on the die.

Warning: All V_{CC} and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.

Figure 1. Pinout Assignment (Top View)

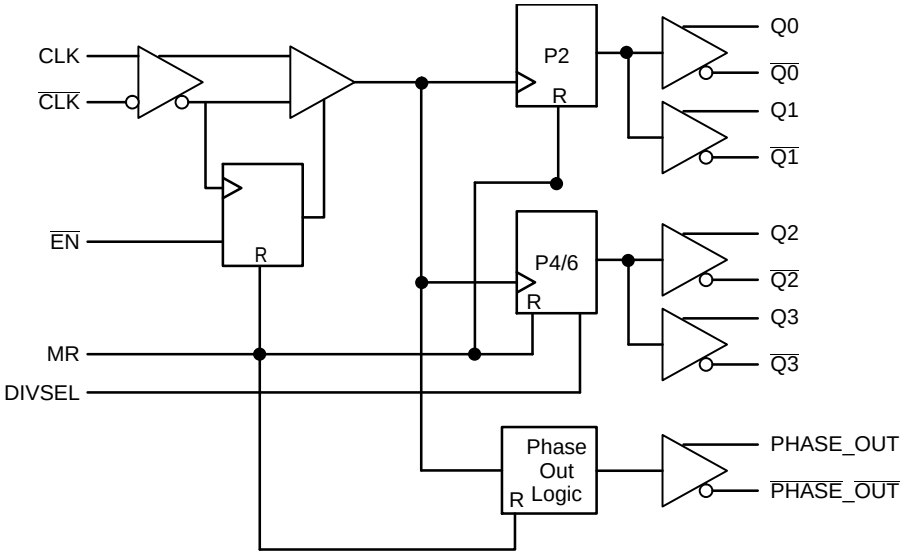


Figure 2. Logic Diagram

Table 1. PIN DESCRIPTION

Pin	Function
CLK, $\overline{CLK}$	ECL Diff Clock Inputs
Q_0, Q_1; $\overline{Q_0}$, $\overline{Q_1}$	ECL Diff ÷2 Outputs
Q_2, Q_3; $\overline{Q_2}$, $\overline{Q_3}$	ECL Diff ÷4/6 Outputs
$\overline{EN}$	ECL Sync Enable Input
MR	ECL Master Reset Input
DIVSEL	ECL Frequency Select Input
Phase_Out, $\overline{Phase\_Out}$	ECL Phase Sync Diff. Signal Output
V_{BB}	Reference Voltage Output
V_{CC}	Positive Supply
V_{EE}	Negative Supply

Table 2. FUNCTION TABLE

CLK	$\overline{EN}$	MR	Function
Z	L	L	Divide
ZZ	H	L	Hold Q_{0-3}
X	X	H	Reset Q_{0-3}

Z = Low-to-High Transition
ZZ = High-to-Low Transition
X = Don't Care

DIVSEL	Q_2, Q_3 OUTPUTS
L	Divide by 4
H	Divide by 6

MAXIMUM RATINGS

	Parameter	Condition 1	Condition 2	Rating	Unit
	PECL Mode Power Supply	V_{EE} = 0 V		8	V
	NECL Mode Power Supply	V_{CC} = 0 V		−8	V
	PECL Mode Input Voltage NECL Mode Input Voltage	V_{EE} = 0 V V_{CC} = 0 V	$V_I \le V_{CC}$ $V_I \ge V_{EE}$	6 −6	V
	Output Current	Continuous Surge		50 100	MA
	V_{BB} Sink/Source			± 0.5	mA
	Operating Temperature Range			−40 to +85	°C
	Storage Temperature Range			−65 to +150	°C
	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	SOIC−20 WB	90 60	°C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	Standard Board	SOIC−20 WB	30 to 35	

Table 5. 100EL SERIES NECL DC CHARACTERISTICS (V_{CC} = 0.0 V; V_{EE} = −5.0 V (Note 1))

Symbol	Characteristic	−40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
I_{EE}	Power Supply Current		50	60		50	60		54	65	mA
V_{OH}	Output HIGH Voltage (Note 2)	−1085	−1005	−880	−1025	−955	−880	−1025	−955	−880	mV
V_{OL}	Output LOW Voltage (Note 2)	−1830	−1695	−1555	−1810	−1705	−1620				

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